

General Description

SXG12N10D use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness and suitable to use in

Features

Low RDS(on) & FOM

Extremely low switching loss

Excellent stability and uniformity of Invertors

Applications

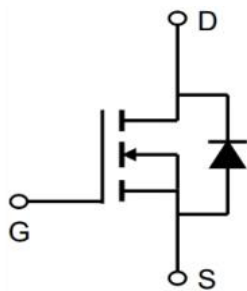
Consumer electronic power supply

Motor control

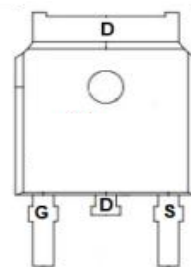
Synchronous-rectification

Isolated DC

Synchronous-rectification applications



TO-252-3L



Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain source voltage	VDS	100	V
Gate source voltage	VGS	± 20	V
Continuous drain current ¹⁾ , $T_c=25^\circ\text{C}$	I _D	12	A
Pulsed drain current ²⁾ , $T_c=25^\circ\text{C}$	I _D , pulse	24	A
Power dissipation ³⁾ , $T_c=25^\circ\text{C}$	P _D	17	W
Single pulsed avalanche energy ⁵⁾	EAS	1.2	mJ
Operation and storage temperature	T _{stg} , T _j	-55 to 150	$^\circ\text{C}$
Thermal resistance, junction-case	R _{θJC}	7.4	$^\circ\text{C/W}$
Thermal resistance, junction-ambient ⁴⁾	R _{θJA}	62	$^\circ\text{C/W}$

Electrical Characteristics at $T_J=25\text{ }^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
BV_{DS}	Drain-source breakdown voltage	$V_{GS}=0\text{ V}$, $I_D=250\text{ }\mu\text{A}$	100	111		V
$V_{GS(th)}$	Gate threshold voltage	$V_{DS}=V_{GS}$, $I_D=250\text{ }\mu\text{A}$	1.2	2.0	2.5	V
$R_{DS(on)}$	Drain-source on-state resistance	$V_{GS}=10\text{ V}$, $I_D=5\text{ A}$		105	125	m Ω
$R_{DS(on)}$	Drain-source on-state resistance	$V_{GS}=4.5\text{ V}$, $I_D=3\text{ A}$		115	145	m Ω
I_{GSS}	Gate-source leakage current	$V_{GS}=20\text{ V}$			100	nA
		$V_{GS}=-20\text{ V}$			-100	
I_{DSS}	Drain-source leakage current	$V_{DS}=100\text{ V}$, $V_{GS}=0\text{ V}$			1	μA
C_{iss}	Input capacitance	$V_{GS}=0\text{ V}$, $V_{DS}=50\text{ V}$, $f=100\text{ kHz}$		206.1		pF
C_{oss}	Output capacitance			28.9		pF
C_{rss}	Reverse transfer capacitance			1.4		pF
$t_{d(on)}$	Turn-on delay time	$V_{GS}=10\text{ V}$, $V_{DS}=50\text{ V}$, $R_G=2\text{ }\Omega$, $I_D=5\text{ A}$		14.7		ns
t_r	Rise time			3.5		ns
$t_{d(off)}$	Turn-off delay time			20.9		ns
t_f	Fall time			2.7		ns
Q_g	Total gate charge	$I_D=5\text{ A}$, $V_{DS}=50\text{ V}$, $V_{GS}=10\text{ V}$		4.3		nC
Q_{gs}	Gate-source charge			1.5		nC
Q_{gd}	Gate-drain charge			1.1		nC
$V_{plateau}$	Gate plateau voltage			5.0		V
I_S	Diode forward current	$V_{GS}<V_{th}$			7	A
I_{SP}	Pulsed source current				21	
V_{SD}	Diode forward voltage	$I_S=7\text{ A}$, $V_{GS}=0\text{ V}$			1.0	V
t_{rr}	Reverse recovery time	$I_S=5\text{ A}$, $di/dt=100\text{ A}/\mu\text{s}$		32.1		ns
Q_{rr}	Reverse recovery charge			39.4		nC
I_{rrm}	Peak reverse recovery current			2.1		A

Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) P_d is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of $R_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with $T_a=25\text{ }^{\circ}\text{C}$.
- 5) $V_{DD}=50\text{ V}$, $R_G=50\text{ }\Omega$, $L=0.3\text{ mH}$, starting $T_J=25\text{ }^{\circ}\text{C}$.

Electrical Characteristics Diagrams

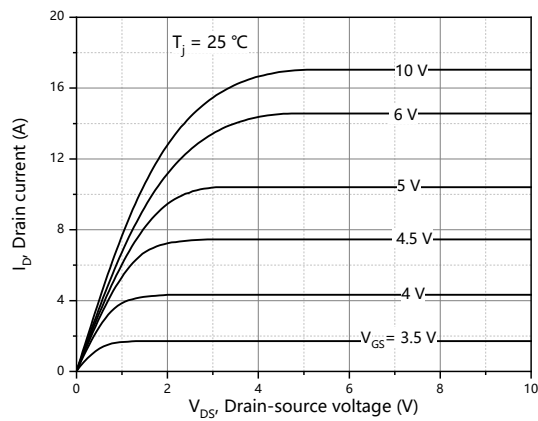


Figure 1, Typ. output characteristics

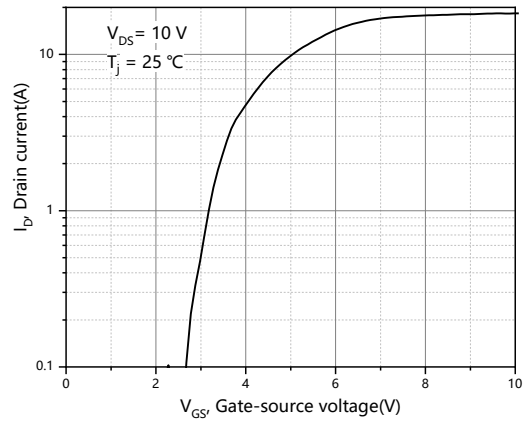


Figure 2, Typ. transfer characteristics

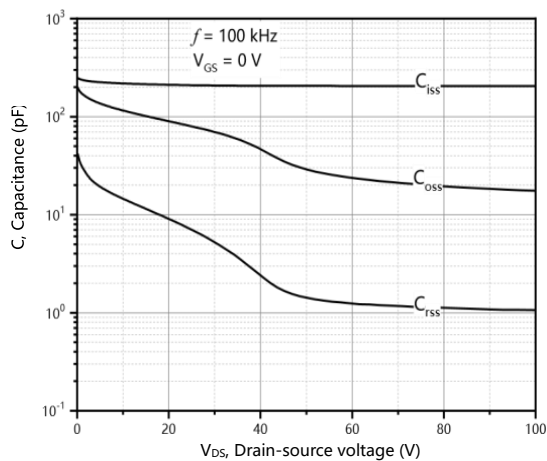


Figure 3, Typ. capacitances

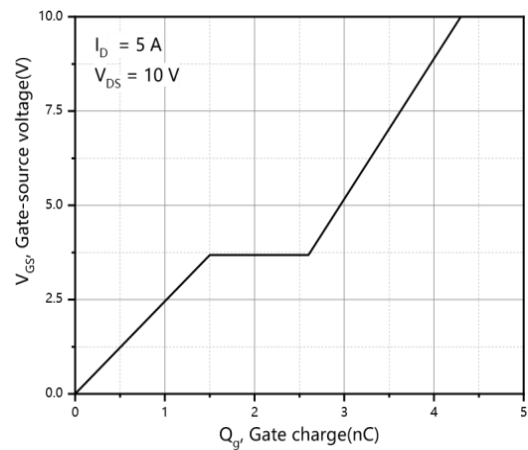


Figure 4, Typ. gate charge

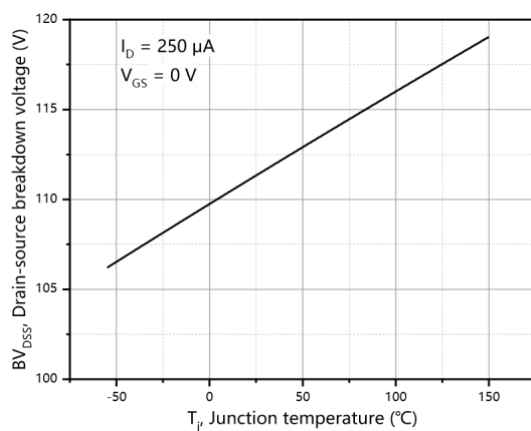


Figure 5, Drain-source breakdown voltage

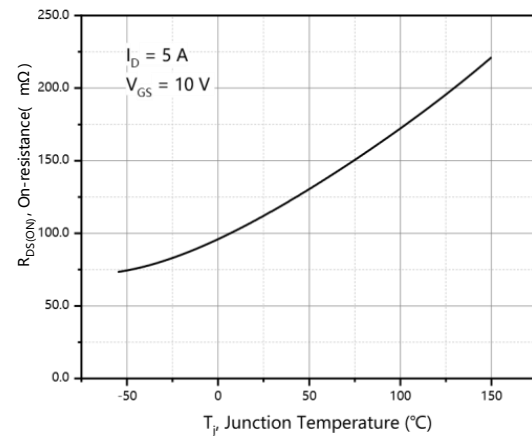


Figure 6, Drain-source on-state resistance

Typical Characteristics

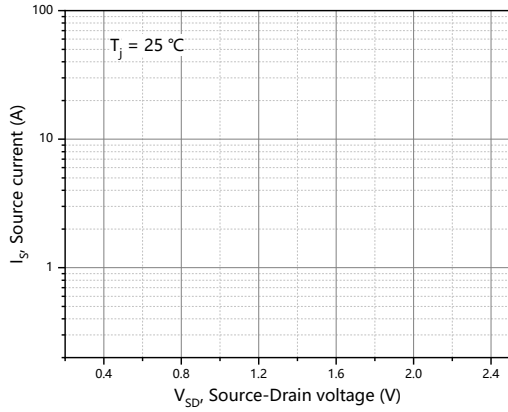


Figure 7, Forward characteristic of body diode

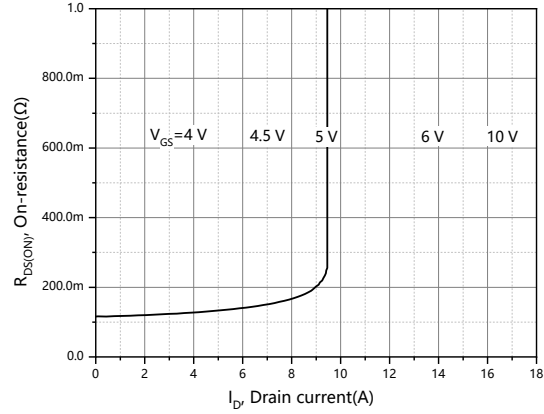


Figure 8, Drain-source on-state resistance

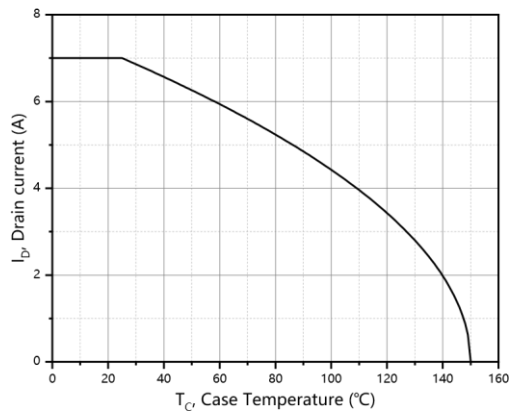


Figure 9, Drain current

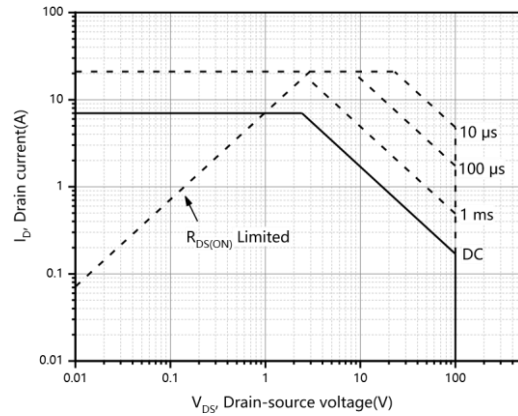


Figure 10, Safe operation area $T_C = 25\text{ }^{\circ}\text{C}$

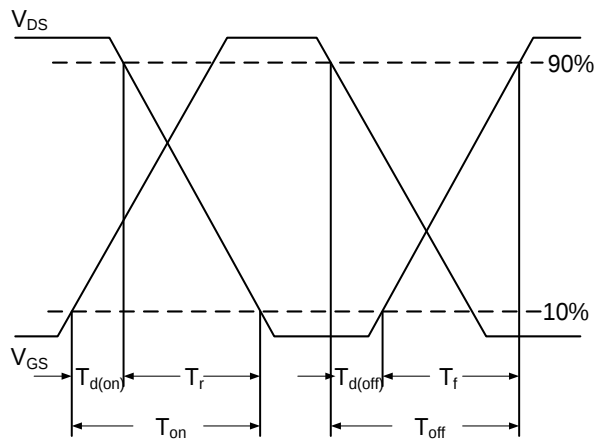


Fig.11 Switching Time Waveform

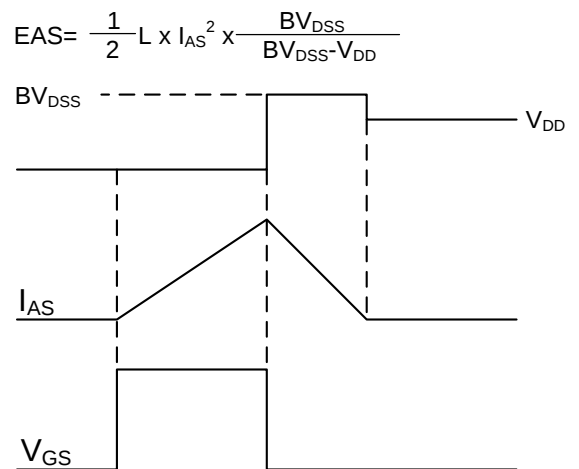
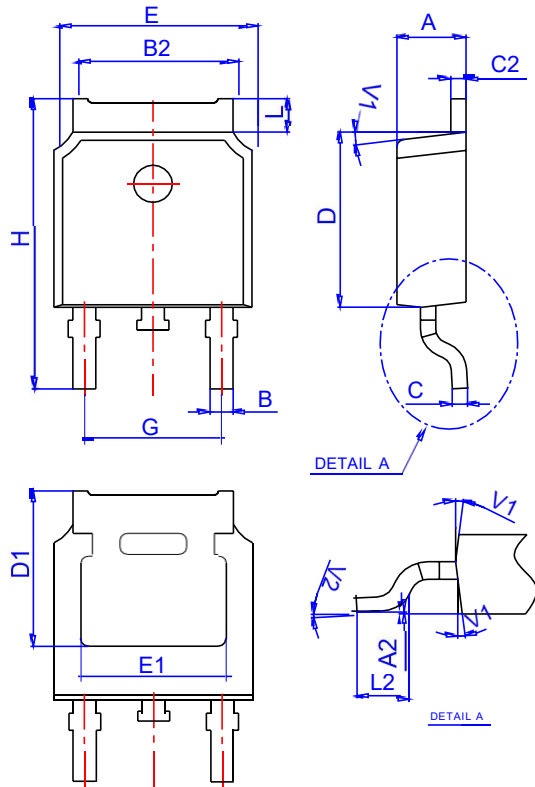


Fig.12 Unclamped Inductive Switching Waveform

Package Mechanical Data-TO-252-3L



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
TAPING	TO-252-3L		2500